

40V PNP SURFACE MOUNT SMALL SIGNAL TRANSISTOR IN SOT23

Features

- Epitaxial Planar Die Construction
- Complementary NPN Type Available (MMBT4401)
- Ideal for Medium Power Amplification and Switching
- Lead Free, RoHS Compliant (Note 1)
- Halogen and Antimony Free "Green" Device (Note 2)
- Qualified to AEC-Q101 Standards for High Reliability

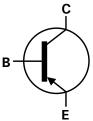
Mechanical Data

- Case: SOT23
- UL Flammability Rating 94V-0
- Case material: molded Plastic "Green" Compound
- Moisture Sensitivity: Level 1 per J-STD-020
- Terminals: Matte Tin Finish
- Weight: 0.008 grams (Approximate)

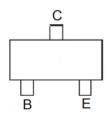




Top View



Device Symbol



Top View Pin-Out

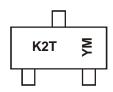
Ordering Information (Note 3)

| Ī | Product | Marking | Reel size (inches) | Tape width (mm) | Quantity per reel |
|---|--------------|---------|--------------------|-----------------|-------------------|
| | MMBT4403-7-F | K2T | 7 | 8 | 3,000 |

Notes:

- 1. No purposefully added lead.
- 2. Diodes Inc.`s "Green" Policy can be found on our website at http://www.diodes.com
- 3. For more packaging details, go to our website at http://www.diodes.com.

Marking Information



K2T = Product Type Marking Code YM = Date Code Marking Y = Year (ex: Y = 2011) M = Month (ex: 9 = September)

Date Code Key

| Year | 2010 | 20 | 011 | 2012 | 2 | 2013 | 2014 | | 2015 | 2016 | | 2017 |
|-------|------|-----|-----|------|-----|------|------|-----|------|------|-----|------|
| Code | Χ | | Υ | Z | | Α | В | | С | D | | E |
| Month | Jan | Feb | Mar | Apr | May | Jun | Jul | Aug | Sep | Oct | Nov | Dec |
| Code | 1 | 2 | 3 | 4 | 5 | 6 | 7 | 8 | 9 | 0 | N | D |



Maximum Ratings @T_A = 25°C unless otherwise specified

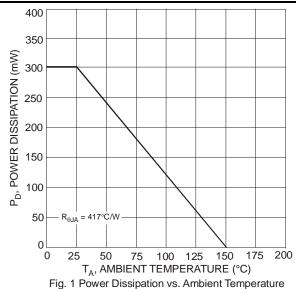
| Characteristic | Symbol | Value | Unit |
|---|------------------|-------|------|
| Collector-Base Voltage | V_{CBO} | -40 | V |
| Collector-Emitter Voltage | V _{CEO} | -40 | V |
| Emitter-Base Voltage | V_{EBO} | -5.0 | V |
| Collector Current - Continuous (Note 4) | Ic | -600 | mA |

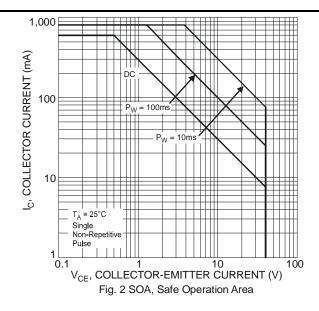
Thermal Characteristics @TA = 25°C unless otherwise specified

| Characteristic | Symbol | Value | Unit | |
|--|-----------------------------------|-----------------|------|------|
| Power Dissipation | (Note 4) | P _D | 300 | mW |
| Thermal Resistance, Junction to Ambient (Note 4) | | $R_{\theta JA}$ | 417 | °C/W |
| Operating and Storage Temperature Range | T _J , T _{STG} | -55 to +150 | °C | |

Notes: 4. Device mounted on FR-4 PCB, 1 inch x 0.85 inch x 0.062 inch

Typical Thermal Characteristics







Electrical Characteristics @T_A = 25°C unless otherwise specified

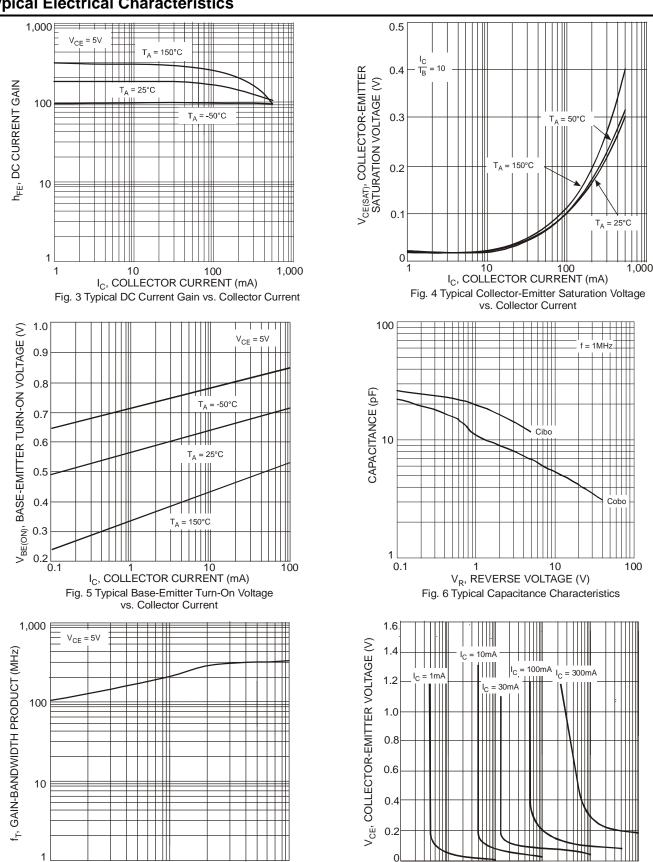
| Characteristic | Symbol | Min | Max | Unit | Test Condition | |
|--------------------------------------|-----------------------|-------|-------|--------------------|---|--|
| OFF CHARACTERISTICS (Note 5) | | | | | | |
| Collector-Base Breakdown Voltage | V _(BR) CBO | -40 | | V | $I_C = -100 \mu A$, $I_E = 0$ | |
| Collector-Emitter Breakdown Voltage | V _{(BR)CEO} | -40 | _ | V | $I_C = -1.0 \text{mA}, I_B = 0$ | |
| Emitter-Base Breakdown Voltage | $V_{(BR)EBO}$ | -5.0 | | V | $I_E = -100 \mu A, I_C = 0$ | |
| Collector Cutoff Current | I _{CEX} | | -100 | nA | $V_{CE} = -35V, V_{EB(OFF)} = -0.4V$ | |
| Base Cutoff Current | I _{BL} | | -100 | nA | $V_{CE} = -35V, V_{EB(OFF)} = -0.4V$ | |
| ON CHARACTERISTICS (Note 5) | | | | | | |
| | | 30 | _ | | $I_C = -100\mu A, V_{CE} = -1.0V$ | |
| | | 60 | _ | | $I_C = -1.0 \text{mA}, V_{CE} = -1.0 \text{V}$ | |
| DC Current Gain | h _{FE} | 100 | _ | | $I_C = -10 \text{mA}, V_{CE} = -1.0 \text{V}$ | |
| | | 100 | 300 | | $I_C = -150 \text{mA}, V_{CE} = -2.0 \text{V}$ | |
| | | 20 | | | $I_C = -500 \text{mA}, V_{CE} = -2.0 \text{V}$ | |
| Collector-Emitter Saturation Voltage | V _{CE(SAT)} | _ | -0.40 | V | $I_C = -150 \text{mA}, I_B = -15 \text{mA}$ | |
| Constitution Catalation Voltage | VCE(SAT) | | -0.75 | | $I_C = -500 \text{mA}, I_B = -50 \text{mA}$ | |
| Base-Emitter Saturation Voltage | V _{BE(SAT)} | -0.75 | -0.95 | V | $I_C = -150 \text{mA}, I_B = -15 \text{mA}$ | |
| · · | | | -1.30 | • | $I_C = -500 \text{mA}, I_B = -50 \text{mA}$ | |
| SMALL SIGNAL CHARACTERISTICS | | | | | + | |
| Output Capacitance | C _{obo} | | 8.5 | pF | $V_{CB} = -10V, f = 1.0MHz, I_E = 0$ | |
| Input Capacitance | C _{ibo} | _ | 30 | pF | $V_{EB} = -0.5V$, $f = 1.0MHz$, $I_{C} = 0$ | |
| Input Impedance | h _{ie} | 1.5 | 15 | kΩ | | |
| Voltage Feedback Ratio | h _{re} | 0.1 | 8.0 | x 10 ⁻⁴ | $V_{CE} = -10V, I_{C} = -1.0mA,$ | |
| Small Signal Current Gain | h _{fe} | 60 | 500 | _ | f = 1.0kHz | |
| Output Admittance | h _{oe} | 1.0 | 100 | μS | | |
| Current Gain-Bandwidth Product | f _T | 200 | | MHz | V _{CE} = -10V, I _C = -20mA, f = 100MHz | |
| SWITCHING CHARACTERISTICS | | | | | | |
| Delay Time | t _d | | 15 | ns | $V_{CC} = -30V, I_{C} = -150mA,$ | |
| Rise Time | t _r | | 20 | ns | $V_{BE(off)} = -2.0V, I_{B1} = -15mA$ | |
| Storage Time | ts | _ | 225 | ns | V _{CC} = -30V, I _C = -150mA, | |
| Fall Time | t _f | | 30 | ns | $I_{B1} = I_{B2} = -15\text{mA}$ | |

Note:

5. Short duration pulse test used to minimize self-heating effect.



Typical Electrical Characteristics



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10 I_C, COLLECTOR CURRENT (mA)

Fig. 7 Typical Gain-Bandwidth Product vs. Collector Current

100

0.001

0.01

0.1

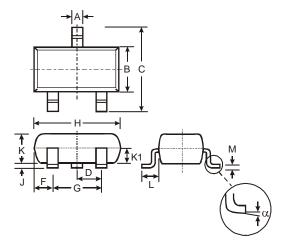
 I_B ,BASE CURRENT (mA)

Fig. 8 Typical Collector Saturation Region

100

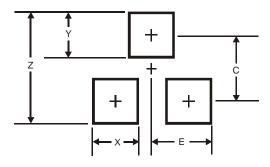


Package Outline Dimensions



| SOT23 | | | | | | | |
|-------|----------------------|------|-------|--|--|--|--|
| Dim | Min | Max | Тур | | | | |
| Α | 0.37 | 0.51 | 0.40 | | | | |
| В | 1.20 | 1.40 | 1.30 | | | | |
| С | 2.30 | 2.50 | 2.40 | | | | |
| D | 0.89 | 1.03 | 0.915 | | | | |
| F | 0.45 | 0.60 | 0.535 | | | | |
| G | 1.78 | 2.05 | 1.83 | | | | |
| Н | 2.80 | 3.00 | 2.90 | | | | |
| J | 0.013 | 0.10 | 0.05 | | | | |
| K | 0.903 | 1.10 | 1.00 | | | | |
| K1 | - | - | 0.400 | | | | |
| L | 0.45 | 0.61 | 0.55 | | | | |
| М | 0.085 | 0.18 | 0.11 | | | | |
| α | 0° | 8° | - | | | | |
| All | All Dimensions in mm | | | | | | |

Suggested Pad Layout



| Dimensions | Value (in mm) | |
|------------|---------------|--|
| Z | 2.9 | |
| Х | 0.8 | |
| Υ | 0.9 | |
| С | 2.0 | |
| E | 1.35 | |



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